

CALL FOR PAPERS WCSP 2023

Wireless Data Privacy and Communication Security Symposium

November 2-4, 2023, Hangzhou, China http://www.ic-wcsp.org

Overview: The annual International Conference on Wireless Communications and Signal Processing (WCSP) aims to provide a forum that brings together international researchers from academia and practitioners in industry to meet and exchange ideas and recent research work on all aspects of wireless communications and signal processing. Following the great success of WCSP 2009-2022, the 15th edition of the event, WCSP 2023, will be held in Hangzhou, Zhejiang, China, on November 2-4, 2023. The conference will be sponsored and organized by Zhejiang University, China, and technically co-sponsored by IEEE and IEEE Communications Society.

Scope: Wireless Data Privacy and Communication Security Symposium seeks original contributions in the following topical areas, plus others that are not explicitly listed but are closely related:

- Anonymous communications, metrics, and performance
- Applied cryptography for cyber, information, and network security
- Artificial intelligence for Network Security
- Attack detection and prevention
- Authentication protocols and key management
- Physical-layer security
- Blockchain security and privacy
- Internet of Things security and privacy
- Social network security and privacy
- UAV and vehicular network security

- Security and privacy for wireless networks
- Security and privacy for next-generation networks
- Security and privacy in healthcare systems
- Security and privacy in smart grid communications
- Security tools for communication and information systems
- Signal processing for security enhancement
- Trust and security modeling
- Secure protocol design
- Trust management in networks through emerging technology

Submission and Publication: Please visit the conference website at www.ic-wcsp.org for submission instructions. All accepted and presented papers will be included in the WCSP 2023 Conference Proceedings and submitted for inclusion in IEEE Xplore Digital Library.

Important Dates: Submission deadline: June 30, 2023

Acceptance notification: Aug. 30, 2023 Camera-ready paper: Sept. 1, 2023

Symposium Co-Chairs: Liang Xiao, Xiamen University, China

Lifeng Lai, UC Davis, USA

Yulong Zou, Nanjing University of Posts and Telecommunications, China

Hui-Ming Wang, Xi'an Jiaotong University, China

Xiaofan He, Wuhan University, China